

Product Specification

NHD-2.7-12864WDY3M-CTP

Graphic OLED Display Module

NHD-	Newhaven Display
2.7-	2.7" Diagonal Size
12864-	128 x 64 Pixel Resolution
WD-	Model
Y-	Emitting Color: Yellow
3-	3.3V Power Supply
M-	Molex (52271-2079) Connector Interface
CTP-	Capacitive Touch Panel

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Additional Resources

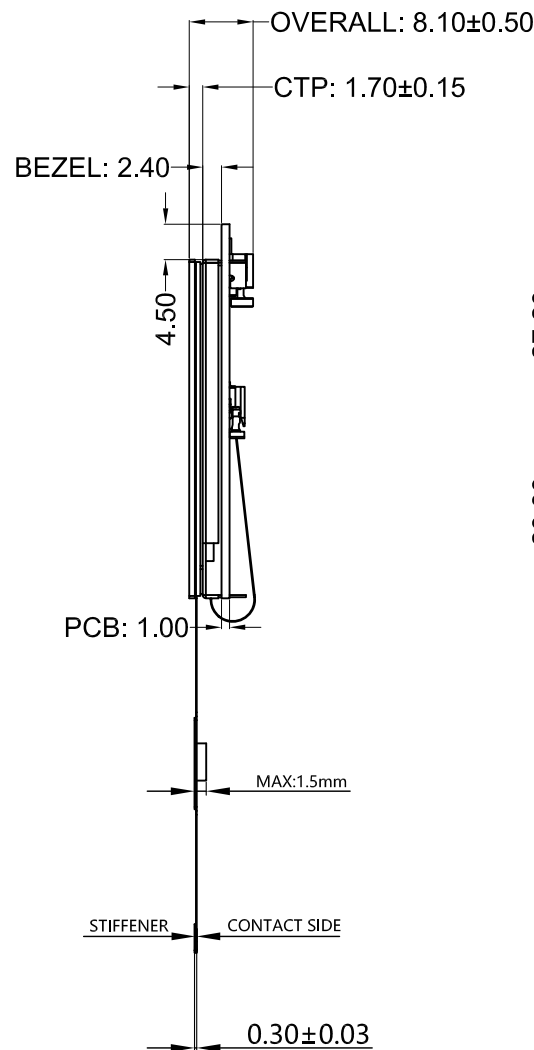
- **Support Forum:** <https://support.newhavendisplay.com/hc/en-us/community/topics>
- **GitHub:** <https://github.com/newhavendisplay>
- **Example Code:** <https://support.newhavendisplay.com/hc/en-us/categories/4409527834135-Example-Code/>
- **Knowledge Center:** https://www.newhavendisplay.com/knowledge_center.html
- **Quality Center:** https://www.newhavendisplay.com/quality_center.html
- **Precautions for using LCDs/LCMs:** <https://www.newhavendisplay.com/specs/precautions.pdf>
- **Warranty / Terms & Conditions:** <https://www.newhavendisplay.com/terms.html>



Document Revision History

Revision	Date	Description	Changed By
-	08/20/2023	Initial Release	KL
1	07/31/2024	Maximum Supply Voltage for Boost Converter Updated from 12V to 5.5V	KL

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CTP	
PIN	DEFINE
1	VDD 3.3V
2	GND
3	SCL 3.3V
4	SDA 3.3V
5	INT 3.3V
6	RESET 3.3V

1. Driver IC: SSD1322 OLED, FT5426-003 CTP
2. Interface: 8-bit 6800/8080 Parallel, 3/4-wire SPI OLED, I²C CTP
3. Power Requirement: 3.3V OLED, 3.3V CTP
4. Optical Features: Yellow Color, Full View
5. Recommended OLED Cable: 20pin 1.0mm pitch FFC; Ex. Molex 52271-2079
6. Recommended CTP Connector: 6pin 1.0mm pitch; Ex. Molex 52271-0679
7. EMI Shielded FPC

Standard Tolerance: (Unless otherwise specified) Linear: $\pm 0.3\text{mm}$	 NEWHAVEN DISPLAY INTERNATIONAL	
	Drawing/Part Number: NHD-2.7-12864WDY3M-CTP	Revision: -
Unless otherwise specified: • Dimensions are in Millimeters • Third Angle Projection 	Drawn By: K. Lewis	Approved By: K. Lewis
	Drawn Date: 07/13/2023	Approved Date: 07/13/2023
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Pin Description

Parallel Interface:

Pin No.	Symbol	External Connection	Function Description
1	V _{SS}	Power Supply	Ground
2	V _{DD}	Power Supply	Supply Voltage for OLED module
3	NC (BC_V _{DD})	-	No Connect by default. Can be configured to power the boost converter independently. (refer to On-Board Jumper Options section)
4	D/C	MPU	Data/Command select signal, D/C=0: Command; D/C=1: Data
5	R/W /WR	MPU	6800 mode: Read/Write select signal, R/W=1: Read, R/W=0: Write 8080 mode: Active LOW Write signal
6	E /RD	MPU	6800 mode: Operation Enable signal. Falling edge triggered. 8080 mode: Active LOW Read signal
7-14	DB0 – DB7	MPU	8-bit bi-directional Data Bus
15	NC (V _{CC})	-	No Connect by default. Can be configured to power V _{CC} independently. (refer to On-Board Jumper Options section)
16	/RES	MPU	Active LOW Reset signal
17	/CS	MPU	Active LOW Chip Select signal
18	/SHDN	MPU	Active LOW Shutdown signal for boost converter (internally pulled HIGH).
19	BS1	MPU	MPU Interface select signal
20	BS0	MPU	MPU Interface select signal

Serial Interface:

Pin No.	Symbol	External Connection	Function Description
1	V _{SS}	Power Supply	Ground
2	V _{DD}	Power Supply	Supply Voltage for OLED module
3	NC (BC_V _{DD})	-	No Connect by default. Can be configured to power the boost converter independently. (refer to On-Board Jumper Options section)
4	D/C	MPU	Data/Command select signal, D/C=0: Command; D/C=1: Data Tie LOW for 3-wire SPI
5-6	V _{SS}	Power Supply	Ground
7	SCLK	MPU	Serial Clock signal
8	SDIN	MPU	Serial Data Input signal
9	NC	-	No Connect
10-14	V _{SS}	Power Supply	Ground
15	NC (V _{CC})	-	No Connect by default. Can be configured to power V _{CC} independently. (refer to On-Board Jumper Options section)
16	/RES	MPU	Active LOW Reset signal
17	/CS	MPU	Active LOW Chip Select signal
18	/SHDN	MPU	Active LOW Shutdown signal for boost converter (internally pulled HIGH).
19	BS1	MPU	MPU Interface select signal
20	BS0	MPU	MPU Interface select signal

Capacitive Touch Panel:

Pin No.	Symbol	External Connection	Function Description
1	V _{DD}	Power Supply	Supply voltage for Logic
2	V _{SS}	Power Supply	Ground
3	SCL	MPU	Serial I2C Clock (Requires 4.7KΩ pull-up resistor)
4	SDA	MPU	Serial I2C Data (Requires 4.7kΩ pull-up resistor)
5	/INT	MPU	Interrupt signal from touch panel module to host
6	/RESET	MPU	Active LOW Reset signal

Recommended connector: 6pin, 1.0mm pitch, FFC connector. Molex P/N 52271-0679



Interface Selection

MPU Interface Pin Selections

Pin Name	6800 Parallel 8-bit interface	8080 Parallel 8-bit interface	3-wire Serial Interface	4-wire Serial Interface
BS1	1	1	0	0
BS0	1	0	1	0

MPU Interface Pin Assignment Summary

Bus Interface	Data/Command Interface								Control Signals				
	D7	D6	D5	D4	D3	D2	D1	D0	E	R/W	/CS	D/C	/RES
8-bit 6800	D[7:0]								E	R/W	/CS	D/C	/RES
8-bit 8080	D[7:0]								/RD	/WR	/CS	D/C	/RES
3-wire SPI	Tie LOW					NC	SDIN	SCLK	Tie LOW		/CS	Tie LOW	/RES
4-wire SPI	Tie LOW					NC	SDIN	SCLK	Tie LOW		/CS	D/C	/RES

On-Board Jumper Options

Default Jumper Setting

R4	R5	R7	Description
Close	Open	Open	OLED controller + Boost converter + OLED panel are powered from V _{DD} (pin #2). This allows the full module to be powered by a single low-voltage supply.

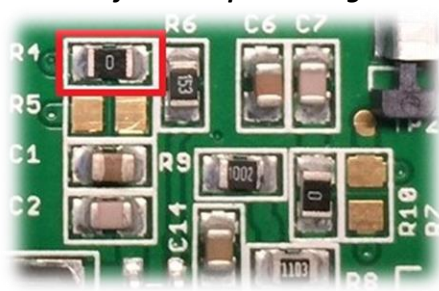
Jumper Option #1 - Independent Supply Voltage for Boost Converter (BC_VDD)

R4	R5	R7	Description
Open	Close	Open	Boost converter + OLED panel are powered from BC_V _{DD} (pin #3). OLED controller is still powered from V _{DD} (pin #2). This allows for increased efficiency through the boost converter by allowing a higher supply voltage at its input, BC_V _{DD} (pin #3).

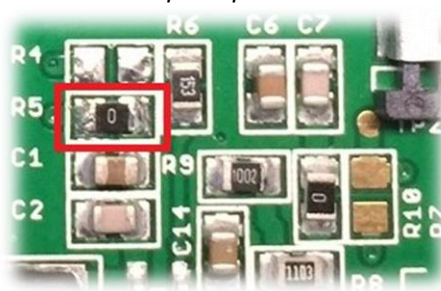
Jumper Option #2 – External Supply Voltage for OLED Panel (VCC)

R4	R5	R7	Description
Open	Open	Close	OLED panel is powered from V _{CC} (pin #15) – boost converter is not used. OLED controller is still powered from V _{DD} (pin #2). This allows for maximum module efficiency, and drastically reduced total current consumption.

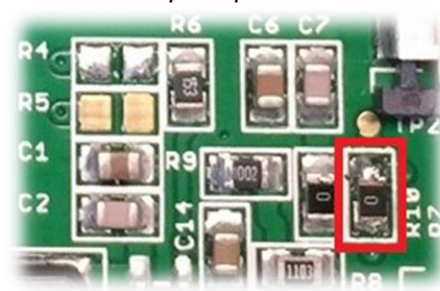
Default Jumper Setting



Jumper Option #1



Jumper Option #2



For detailed electrical information on each jumper option, please see the Electrical Characteristics table below.

Electrical Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Operating Temperature Range	T _{OP}	Absolute Max	-40	-	+85	°C
Storage Temperature Range	T _{ST}	Absolute Max	-40	-	+85	°C
Default Jumper Setting						
Supply Voltage for Module	V_{DD}	-	3.0	3.3	3.5	V
Supply Current for Module	I_{DD}	VDD=3.3V, 100% ON	-	330	360	mA
Jumper Option #1						
Supply Voltage for Module	V _{DD}	-	3.0	3.3	3.5	V
Supply Current for Module	I _{DD}	VDD=3.3V	-	180	295	μA
Supply Voltage for Boost Converter	BC_V _{DD}	-	3.0	5.0	5.5	V
Supply Current for Boost Converter	I _{DD_BC}	BC_VDD=5.0V, 100% ON	-	190	205	mA
Jumper Option #2						
Supply Voltage for Module	V _{DD}	-	3.0	3.3	3.5	V
Supply Current for Module	I _{DD}	V _{DD} =3.3V	-	180	300	μA
Supply Voltage for OLED Panel	V _{CC}	-	14.5	15	15.5	V
Supply Current for OLED Panel	I _{CC}	V _{CC} =15V, 100% ON	-	50	60	mA
Sleep Mode Current	I _{DD_SLEEP}	-	-	25	120	μA
"H" Level input	V _{IH}	-	0.8 * V _{DD}	-	V _{DD}	V
"L" Level input	V _{IL}	-	V _{SS}	-	0.2 * V _{DD}	V
"H" Level output	V _{OH}	-	0.9 * V _{DD}	-	V _{DD}	V
"L" Level output	V _{OL}	-	V _{SS}	-	0.1 * V _{DD}	V

Note: The electrical characteristics shown above for Jumper Option #1 and Jumper Option #2 apply only when the on-board jumpers are configured accordingly. By default, only Default Jumper Setting supply voltage and current (in bold) need to be considered. For details, see On-Board Jumper Options section on previous page.

Capacitive Touch Panel:

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage	V _{DD}	-	2.7	3.3	3.6	V
Supply Current – Operating	I _{DD}	-	-	15	23	mA
"H" Level input	V _{IH}	-	0.7*V _{DD}	-	V _{DD}	V
"L" Level input	V _{IL}	-	V _{SS}	-	0.3*V _{DD}	V
"H" Level output	V _{OH}	-	0.7*V _{DD}	-	V _{DD}	V
"L" Level output	V _{OL}	-	V _{SS}	-	0.3*V _{DD}	V

Optical Characteristics

Item		Symbol	Condition	Min.	Typ.	Max.	Unit
Optimal Viewing Angles	Top	$\phi Y+$	-	-	85	-	°
	Bottom	$\phi Y-$		-	85	-	°
	Left	$\theta X-$		-	85	-	°
	Right	$\theta X+$		-	85	-	°
Contrast Ratio		C_r	-	>10,000:1	-	-	-
Response Time	Rise	T_R	-	-	10	-	μs
	Fall	T_F	-	-	10	-	μs
Brightness		L_V	50% Checkerboard	51	68	-	cd/m^2
Lifetime		-	$T_{OP}=25^{\circ}C, L_V=68cd/m^2$	60,000	-	-	hrs
		-	$T_{OP}=25^{\circ}C, L_V=51cd/m^2$	100,000	-	-	hrs

Note: Lifetime at typical temperature is based on accelerated high-temperature operation. Lifetime is tested at average 50% pixels on and is rated as Hours until **Half-Brightness**. To extend the life of the display, lower values may be used for the contrast setting registers – see below table of commands for details.

Driver/Controller Information

Built-in SSD1322 Controller: <https://support.newhavendisplay.com/hc/en-us/articles/4414477846679-SSD1322>

Built-in FT5426-003 Controller: <https://support.newhavendisplay.com/hc/en-us/articles/4414392845079-FT5x26>



Table of Commands

Instruction	Code										Description	RESET value
	D/C	HEX	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Enable Grayscale Table	0	00	0	0	0	0	0	0	0	0	Enable the Grayscale table settings. (see command 0xB8)	
Set Column Address	0	15	0	0	0	1	0	1	0	1	Set column start and end address	0 119d
	1	A[6:0]	*	A6	A5	A4	A3	A2	A1	A0	A[6:0]: Column start address. Range: 0-119d	
	1	B[6:0]	*	B6	B5	B4	B3	B2	B1	B0	B[6:0]: Column end address. Range: 0-119d	
Write RAM Command	0	5C	0	1	0	1	1	1	0	0	Enable MCU to write Data into RAM	
Read RAM Command	0	5D	0	1	0	1	1	1	0	1	Enable MCU to read Data from RAM	
Set Row Address	0	75	0	1	1	1	0	1	0	1	Set row start and end address	0 127d
	1	A[6:0]	*	A6	A5	A4	A3	A2	A1	A0	A[6:0]: Row start address. Range: 0-127d	
	1	B[6:0]	*	B6	B5	B4	B3	B2	B1	B0	B[6:0]: Row end address. Range: 0-127d	
Set Re-map	0	A0	1	0	1	0	0	0	0	0	A[0] = 0; Horizontal Address Increment	0
	1	A[5:0]	0	0	A5	A4	0	A2	A1	A0	A[0] = 1; Vertical Address Increment	0
	1	B[4]	*	*	0	B4	0	0	0	1	A[1] = 0; Disable Column Address remap A[1] = 1; Enable Column Address remap A[2] = 0; Disable Nibble remap A[2] = 1; Enable Nibble remap A[4] = 0; Scan from COM0 to COM[N-1] A[4] = 1; Scan from COM[N-1] to COM0 A[5] = 0; Disable COM split Odd/Even A[5] = 1; Enable COM split Odd/Even B[4] = 0; Disable Dual COM mode B[4] = 1; Enable Dual COM mode Note: A[5] must be 0 if B[4] is 1.	0 0 0 0 0 0
Set Display Start Line	0	A1	1	0	1	0	0	0	0	1	Set display RAM display start line register from 0-127.	0
	1	A[6:0]	*	A6	A5	A4	A3	A2	A1	A0		
Set Display Offset	0	A2	1	0	1	0	0	0	1	0	Set vertical shift by COM from 0~127.	0
	1	A[6:0]	*	A6	A5	A4	A3	A2	A1	A0		
Display Mode	0	A4~A7	1	0	1	0	0	X2	X1	X0	0xA4 = Entire display OFF 0xA5 = Entire display ON, all pixels Grayscale level 15 0xA6 = Normal display 0xA7 = Inverse display	0xA6
Enable Partial Display	0	A8	1	0	1	0	1	0	0	0	Turns ON partial mode.	
	1	A[6:0]	0	A6	A5	A4	A3	A2	A1	A0	A[6:0] = Address of start row	
	1	B[6:0]	0	B6	B5	B4	B3	B2	B1	B0	B[6:0] = Address of end row (B[6:0] > A[6:0])	
Exit Partial Display	0	A9	1	0	1	0	1	0	0	1	Exit Partial Display mode	
Function Selection	0	AB	1	0	1	0	1	0	1	1	A[0] = 0; External VDD	1
	1	A[0]	0	0	0	0	0	0	0	A0	A[0] = 1; Internal VDD regulator	

[illegible]

Select Default Linear Gray Scale Table	0	B9	1	0	1	1	1	0	0	1	Sets Linear Grayscale table GS0 pulse width = 0 GS0 pulse width = 0 GS0 pulse width = 8 GS0 pulse width = 16 . . . GS0 pulse width = 104 GS0 pulse width = 112	
Set Pre-charge Voltage	0 1	BB A[4:0]	1 *	0 *	1 *	1 A4	1 A3	0 A2	1 A1	1 A0	Set precharge voltage level. A[4:0] = 0x00; 0.20*VCC . . A[4:0] = 0x3E; 0.60*VCC	0x17
Set VCOMH Voltage	0 1	BE A[3:0]	1 *	0 *	1 *	1 *	1 A3	1 A2	1 A1	0 A0	Sets the VCOMH voltage level A[3:0] = 0x00; 0.72*VCC . . A[3:0] = 0x04; 0.8*VCC . . A[3:0] = 0x07; 0.86*VCC	0x04
Set Contrast Control	0 1	C1 A[7:0]	1 A7	1 A6	0 A5	0 A4	0 A3	0 A2	0 A1	1 A0	Double byte command to select 1 out of 256 contrast steps. Contrast increases as the value increases.	0x7F
Master Contrast Control	0 1	C7 A[3:0]	1 *	1 *	0 *	0 *	0 A3	1 A2	1 A1	1 A0	A[3:0] = 0x00; Reduce output for all colors to 1/16 A[3:0] = 0x01; Reduce output for all colors to 2/16 . . A[3:0] = 0x0E; Reduce output for all colors to 15/16 A[3:0] = 0x0F; no change	0x0f
Set Multiplex Ratio	0 1	CA A[6:0]	1 *	1 A6	0 A5	0 A4	1 A3	0 A2	1 A1	0 A0	Set MUX ratio to N+1 MUX N=A[6:0]; from 16MUX to 128MUX (0 to 14 are invalid)	127d
Set Command Lock	0 1	FD A[2]	1 0	1 0	1 0	1 1	1 0	1 A2	0 1	1 0	A[2] = 0; Unlock OLED to enable commands A[2] = 1; Lock OLED from entering commands	0x12

For detailed instruction information, view full SSD1322 datasheet here (pages 32-47):

http://www.newhavendisplay.com/app_notes/SSD1322.pdf

Capacitive Touch Panel Registers

Register No.	Access	Register Name	Bits	Value	Description
01h	RO	Gesture ID	[7:0]	1Ch 14h 10h 18h 49h 48h 00	Swipe Up Swipe Down Swipe Left Swipe Right Zoom Out Zoom In No gesture
02h	RO	Touch Points	[7:0]	0-Ah	0: No touch detected A: 5 touch points detected
03h	RO	TOUCH1_Event_Flag	[7:6]	0 1 2 3	Put Down Put Up Contact Reserved
03h	RO	TOUCH1_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
04h	RO	TOUCH1_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
05h	RO	TOUCH1_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
06h	RO	TOUCH1_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
07h	RO	TOUCH1_Weight	[7:0]		Touch Weight
08h	RO	TOUCH1_Misc	[3:0]	00-0Fh	Touch Area
09h	RO	TOUCH2_Event_Flag	[7:6]	0 1 2 3	Put Down Put Up Contact Reserved
09h	RO	TOUCH1_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
0Ah	RO	TOUCH2_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
0Bh	RO	TOUCH2_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
0Ch	RO	TOUCH2_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
0Dh	RO	TOUCH2_Weight	[7:0]		Touch Weight
0Eh	RO	TOUCH2_Misc	[3:0]	00-0Fh	Touch Area
0Fh	RO	TOUCH3_Event_Flag	[7:6]	0 1 2 3	Put Down Put Up Contact Reserved
0Fh	RO	TOUCH3_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
10	RO	TOUCH3_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
11h	RO	TOUCH3_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
12h	RO	TOUCH3_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
13h	RO	TOUCH3_Weight	[7:0]		Touch Weight
14h	RO	TOUCH3_Misc	[3:0]	00-0Fh	Touch Area
15h	RO	TOUCH4_Event_Flag	[7:6]	0 1 2 3	Put Down Put Up Contact Reserved
15h	RO	TOUCH4_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
16h	RO	TOUCH4_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
17h	RO	TOUCH4_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
18h	RO	TOUCH4_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
1Ah	RO	TOUCH4_Misc	[3:0]	00-0Fh	Touch Area
1Bh	RO	TOUCH5_Event_Flag	[7:6]	0 1 2 3	Put Down Put Up Contact Reserved

Register No.	Access	Register Name	Bits	Value	Description
1Bh	RO	TOUCH5_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
1Ch	RO	TOUCH5_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
1Dh	RO	TOUCH5_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
1Eh	RO	TOUCH5_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
1Fh	RO	TOUCH5_Weight	[7:0]		Touch Weight
20	RO	TOUCH5_Misc	[3:0]	00-0Fh	Touch Area
21h	RO	TOUCH6_Event_Flag	[7:6]	0	Put Down
				1	Put Up
				2	Contact
				3	Reserved
21h	RO	TOUCH6_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
22h	RO	TOUCH6_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
23h	RO	TOUCH6_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
24h	RO	TOUCH6_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
25h	RO	TOUCH6_Weight	[7:0]		Touch Weight
26h	RO	TOUCH6_Misc	[3:0]	00-0Fh	Touch Area
27h	RO	TOUCH7_Event_Flag	[7:6]	0	Put Down
				1	Put Up
				2	Contact
				3	Reserved
27h	RO	TOUCH7_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
28h	RO	TOUCH7_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
29h	RO	TOUCH7_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
2Ah	RO	TOUCH7_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
2Bh	RO	TOUCH7_Weight	[7:0]		Touch Weight
2Ch	RO	TOUCH7_Misc	[3:0]	00-0Fh	Touch Area
2Dh	RO	TOUCH8_Event_Flag	[7:6]	0	Put Down
				1	Put Up
				2	Contact
				3	Reserved
2Dh	RO	TOUCH8_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
2Eh	RO	TOUCH8_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
2Fh	RO	TOUCH8_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
30	RO	TOUCH8_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
31h	RO	TOUCH8_Weight	[7:0]		Touch Weight
32h	RO	TOUCH8_Misc	[3:0]	00-0Fh	Touch Area
33h	RO	TOUCH9_Event_Flag	[7:6]	0	Put Down
				1	Put Up
				2	Contact
				3	Reserved
33h	RO	TOUCH9_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
34h	RO	TOUCH9_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
35h	RO	TOUCH9_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
36h	RO	TOUCH9_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate
37h	RO	TOUCH9_Weight	[7:0]		Touch Weight
38h	RO	TOUCH9_Misc	[3:0]	00 - 0Fh	Touch Area
39h	RO	TOUCH10_Event_Flag	[7:6]	0	Put Down
				1	Put Up
				2	Contact
				3	Reserved
39h	RO	TOUCH10_XH	[3:0]	0 - 1	Upper 4 bits of X touch coordinate
3Ah	RO	TOUCH10_XL	[7:0]	00 - FFh	Lower 8 bits of X touch coordinate
3Bh	RO	TOUCH10_YH	[3:0]	0 - 1	Upper 4 bits of Y touch coordinate
3Ch	RO	TOUCH10_YL	[7:0]	00 - FFh	Lower 8 bits of Y touch coordinate

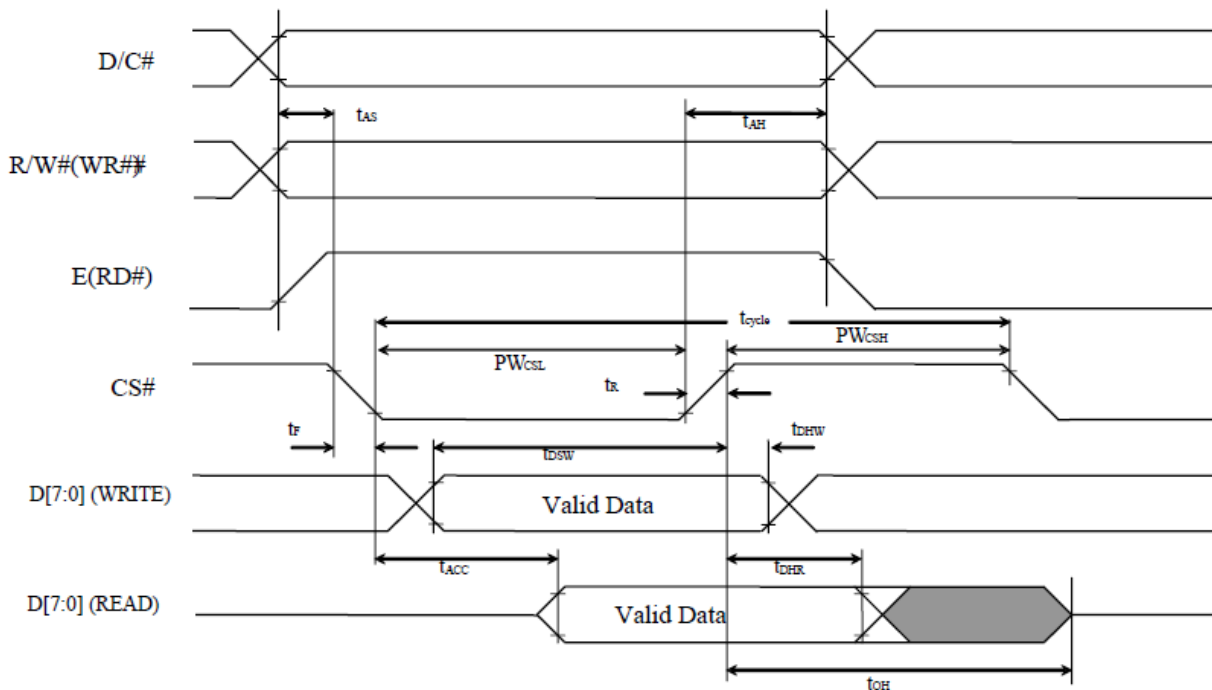
Register No.	Access	Register Name	Bits	Value	Description
3Dh	RO	TOUCH10_Weight	[7:0]	00-FFh	Touch Weight
3Eh	RO	TOUCH10_Misc	[3:0]	00-0Fh	Touch Area
A1h	RO	ID_G_LIB_VERSION_H	[7:0]	00-FFh	App library version high-byte Default: 0
A2h	RO	ID_G_LIB_VERSION_L	[7:0]	00-FFh	App library version low-byte Default: 1h
A3h	RO	ID_G_CHIPER_HIGH	[7:0]	00-FFh	Chip Vendor ID Default: 54h
A6h	RO	ID_G_FIRMID	[7:0]	00-FFh	Firmware ID Number Default: 1
A8h	RO	ID_G_VENODRID	[7:0]	00-FFh	CTPM Vendor's Chip ID Default: 79h

Timing Characteristics – OLED

6800-MPU Parallel Interface

($V_{DDIO} - V_{SS} = 2.1V - V_{CI}$, $V_{CI} - V_{SS} = 2.4V - 3.5V$, $T_A = 25^\circ C$)

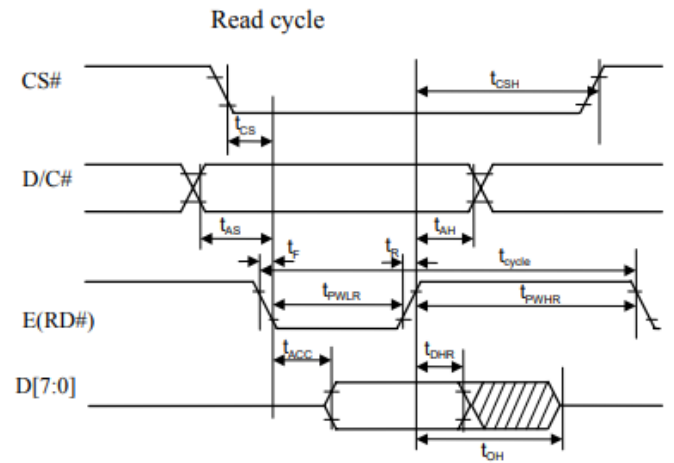
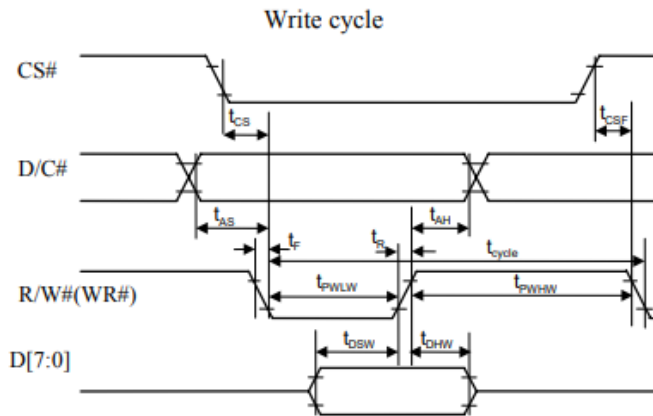
Symbol	Parameter	Min	Typ	Max	Unit
t_{CYCLE}	Clock Cycle Time (read) Clock Cycle Time (write)	300 100	-	-	ns
t_{AS}	Address Setup Time	15	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	10	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (read) Chip Select Low Pulse Width (write)	150 60	-	-	ns
PW_{CSH}	Chip Select High Pulse Width (read) Chip Select High Pulse Width (write)	60 60	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns



8080-MPU Parallel Interface

($V_{DDIO} - V_{SS} = 2.1V - V_{CI}$, $V_{CI} - V_{SS} = 2.4V - 3.5V$, $T_A = 25^\circ C$)

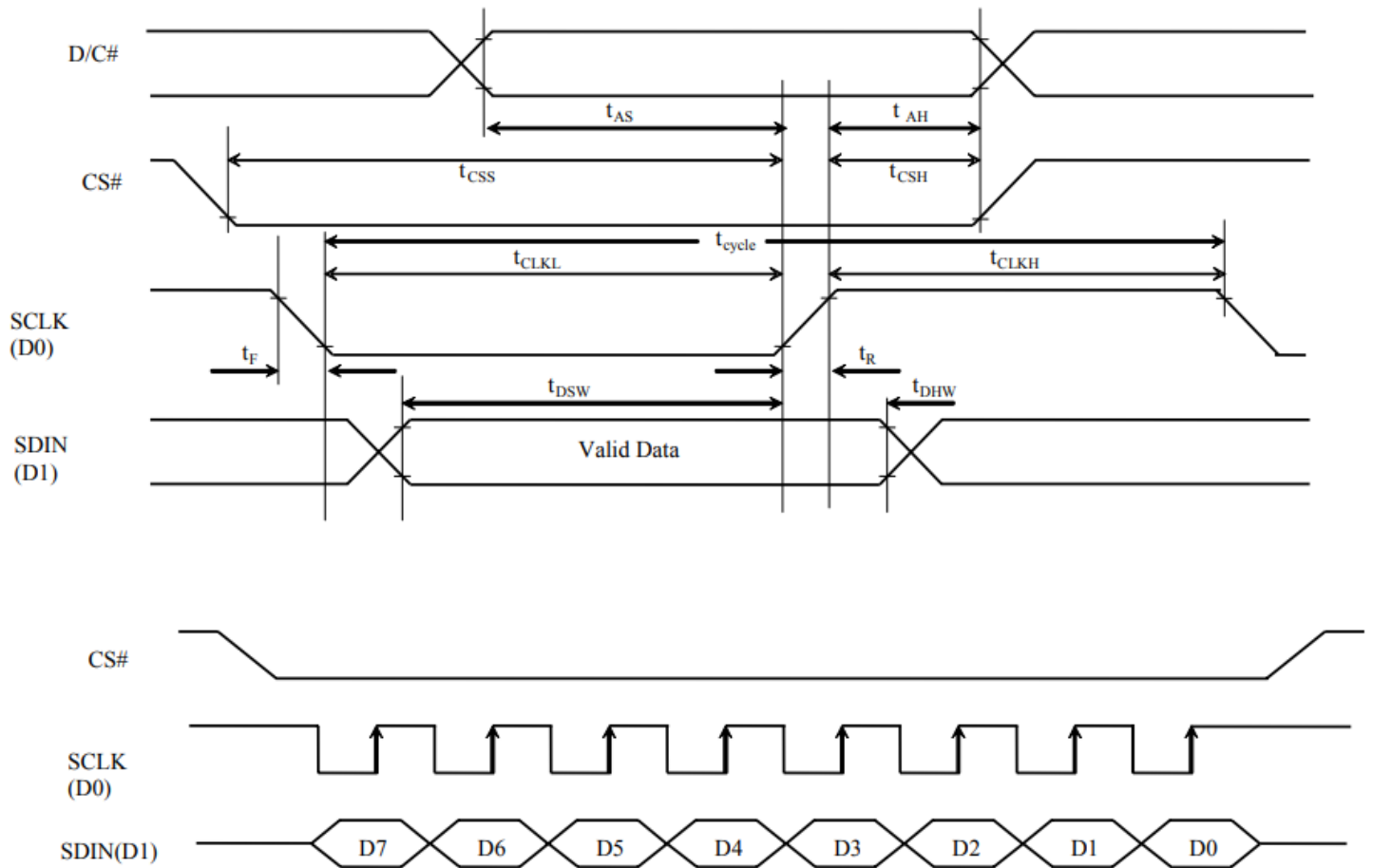
Symbol	Parameter	Min	Typ	Max	Unit
t_{CYCLE}	Clock Cycle Time (read) Clock Cycle Time (write)	300 100	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	10	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
$t_{PWL R}$	Read Low Time	150	-	-	ns
$t_{PWL W}$	Write Low Time	60	-	-	ns
$t_{PWH R}$	Read High Time	60	-	-	ns
$t_{PWH W}$	Write High Time	60	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns
t_{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	-	ns
t_{CSF}	Chip select hold time	20	-	-	ns



Serial Interface (4-wire)

($V_{DDIO} - V_{SS} = 2.1V - V_{CI}$, $V_{CI} - V_{SS} = 2.4V - 3.5V$, $T_A = 25^\circ C$)

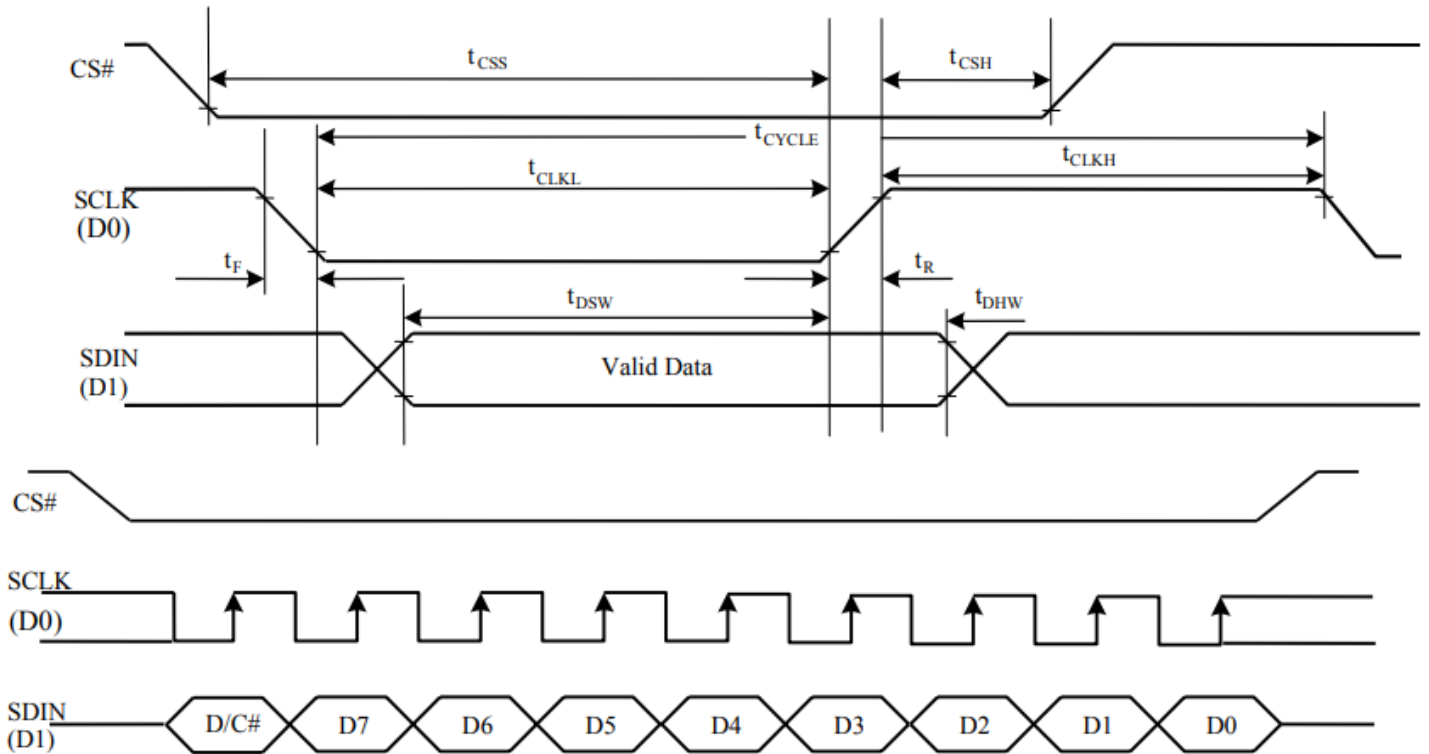
Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	15	-	-	ns
t_{AH}	Address Hold Time	25	-	-	ns
t_{CSS}	Chip Select Setup Time	20	-	-	ns
t_{CSH}	Chip Select Hold Time	10	-	-	ns
t_{DSW}	Write Data Setup Time	15	-	-	ns
t_{DHW}	Write Data Hold Time	20	-	-	ns
t_{CLKL}	Clock Low Time	25	-	-	ns
t_{CLKH}	Clock High Time	40	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns



Serial Interface (3-wire)

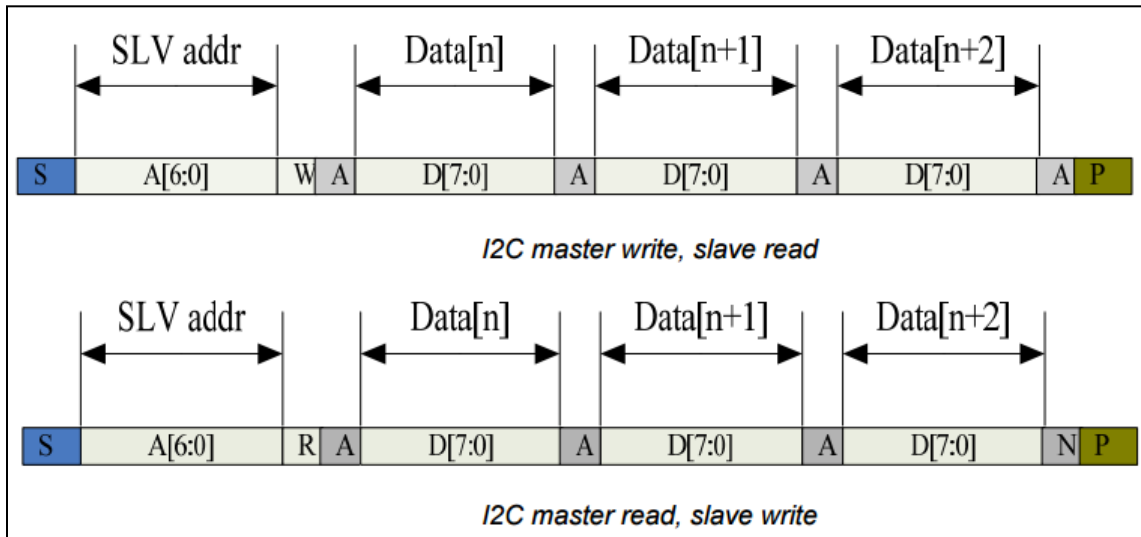
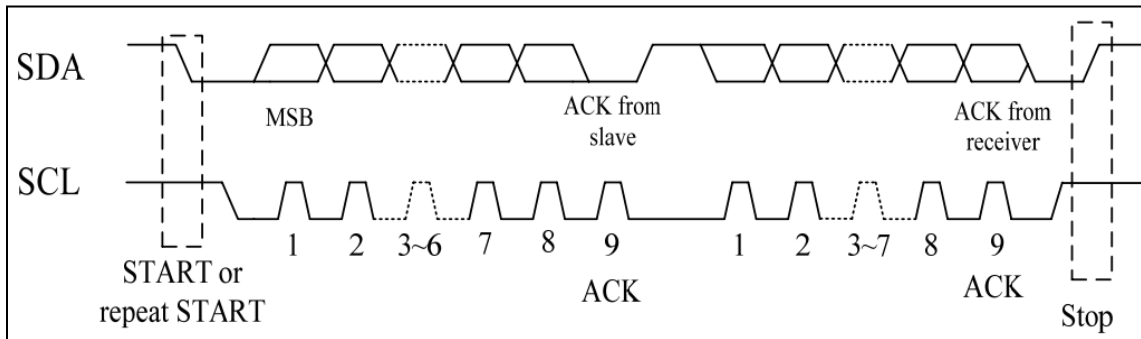
($V_{DDIO} - V_{SS} = 2.1V - V_{CI}$, $V_{CI} - V_{SS} = 2.4V - 3.5V$, $T_A = 25^\circ C$)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{CSS}	Chip Select Setup Time	20	-	-	ns
t_{CSH}	Chip Select Hold Time	25	-	-	ns
t_{DSW}	Write Data Setup Time	15	-	-	ns
t_{DHW}	Write Data Hold Time	20	-	-	ns
t_{CLKL}	Clock Low Time	25	-	-	ns
t_{CLKH}	Clock High Time	25	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns

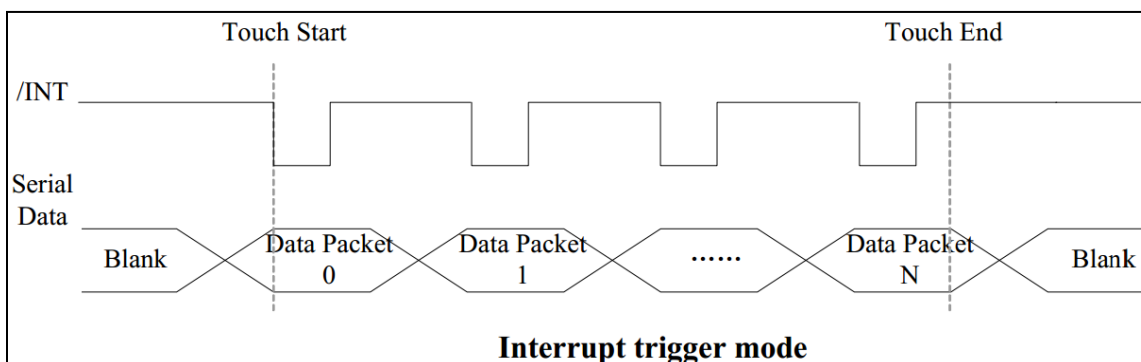


Timing Characteristics – Capacitive Touch Panel

Data Transfer Format



Parameter	Min	Max	Unit
SCL frequency	0	400	KHz
Bus free time between a STOP and START condition	1.3		us
Hold time (repeated) START condition	0.6		us
Data setup time	100		ns
Setup time for a repeated START condition	0.6		us
Setup Time for STOP condition	0.6		us



Power ON / Reset Sequence

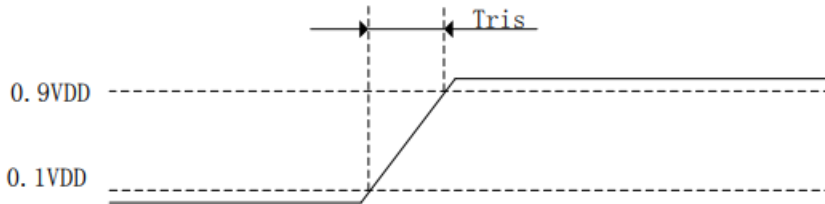


Figure 3-3 Power on time

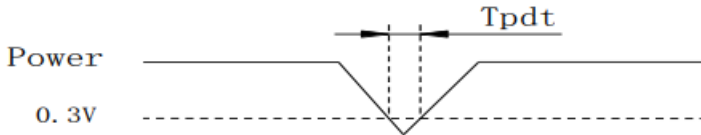


Figure 3-4 Power Cycle requirement

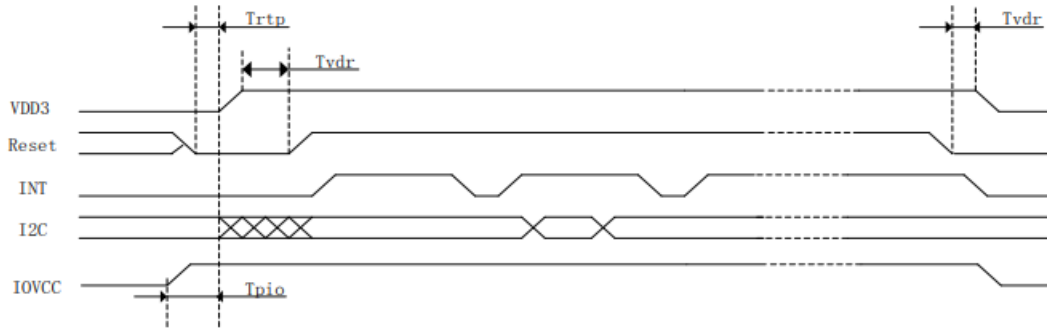


Figure 3-5 Power on Sequence

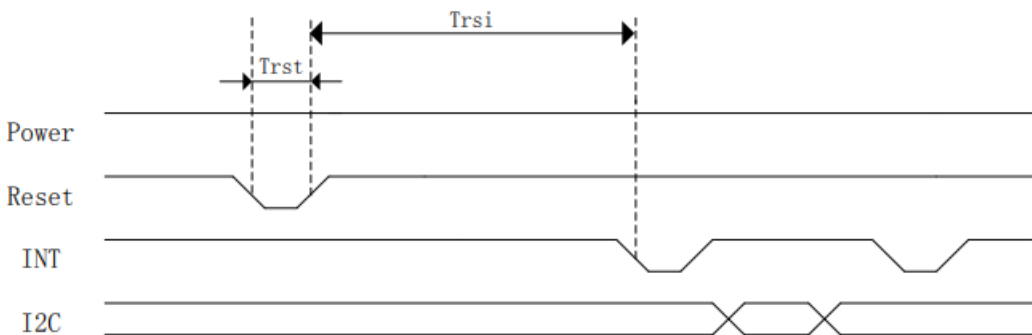


Figure 3-6 Reset Sequence

Parameter	Description	Min	Max	Units
T_{ris}	Rise time from 0.1VDD to 0.9VDD	--	5	ms
T_{pdtd}	Time of the voltage of supply being below 0.3V	5	--	ms
T_{rtp}	Time of resetting to be low before powering on	100	--	μs
T_{vdr}	Reset time after VDD powering on	1	--	ms
T_{rsi}	Time of starting to report point after resetting	--	200	ms
T_{rst}	Reset time	1	--	ms

Example Software Routines

Code to initialize OLED:

```
void NHD12864WDY3_Init(void){
    digitalWrite(RESET, LOW);           //pull /RES (pin #16) low
    delayUS(200);                       //keep /RES low for minimum 200µs
    digitalWrite(RESET, HIGH);          //pull /RES high
    delayUS(200);                       //wait minimum 200µs before sending commands
    writeCommand(0xAE);                 //display OFF
    writeCommand(0xB3);                 //set CLK div. & OSC freq.
    writeData(0x91);
    writeCommand(0xCA);                 //set MUX ratio
    writeData(0x3F);
    writeCommand(0xA2);                 //set offset
    writeData(0x00);
    writeCommand(0xAB);                 //function selection
    writeData(0x01);
    writeCommand(0xA0);                 //set re-map
    writeData(0x16);
    writeData(0x11);
    writeCommand(0xC7);                 //master contrast current
    writeData(0x0F);
    writeCommand(0xC1);                 //set contrast current
    writeData(0x9F);
    writeCommand(0xB1);                 //set phase length
    writeData(0xF2);
    writeCommand(0xBB);                 //set pre-charge voltage
    writeData(0x1F);
    writeCommand(0xB4);                 //set VSL
    writeData(0xA0);
    writeData(0xFD);
    writeCommand(0xBE);                 //set VCOMH
    writeData(0x04);
    writeCommand(0xA6);                 //set display mode
    writeCommand(0xAF);                 //display ON
}
```

Code to read touch data from CTP:

```
i2c_start();
i2c_tx(0x70);           //Slave Address (Write)
i2c_tx(0x00);           //Start reading address
i2c_stop();

i2c_start();
i2c_tx(0x71);           //Slave Address (Read)
for(i=0x00;i<0x1F;i++)
{touchdata_buffer[i] = i2c_rx(1);}
i2c_stop();
```

Quality Information

Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	+85°C, 240hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C, 240hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the high thermal stress for a long time.	+85°C, 240hrs	2
Low Temperature Operation	Endurance test applying the electric stress (voltage & current) and the low thermal stress for a long time.	-40°C, 240hrs	1,2
High Temperature / Humidity Storage	Endurance test applying the electric stress (voltage & current) and the high thermal with high humidity stress for a long time.	+60°C, 90% RH, 240hrs	1,2
Thermal Shock resistance	Endurance test applying the electric stress (voltage & current) during a cycle of low and high thermal stress.	-40°C, 30min -> +25°C, 5min -> +85°C, 30min = 1 cycle 100 cycles	
Vibration test	Endurance test applying vibration to simulate transportation and use.	10-22Hz, 15mm amplitude. 22-500Hz, 1.5G 30min in each of 3 directions X, Y, Z	3
Atmospheric Pressure Test	Test the endurance of the display by applying atmospheric pressure to simulate transportation by air.	115mbar, 40hrs	3
Static electricity test	Endurance test applying electric static discharge.	Air: ±8KV; 300Ω, 150pF	
		Contact: ±4KV; 300Ω, 150pF	

Note 1: No condensation to be observed.

Note 2: Conducted after 8 hours of chamber ramp down to room temperature, and 4 hours of storage at 25°C.

Note 3: Test performed on product itself, not inside a container.